



SSC8338GQ4

Dual Asymmetric N-Channel Enhancement Mode MOSFET

Features

VDS	VGS	RDSON Typ.	ID
2017	±20V	9mR@10V	104
30V		12mR@4V5	16A

> Description

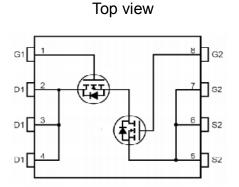
This device uses advanced trench technology to provide excellent RDSON and low gate charge. This device is suitable for use as a load switch or in PWM applications.

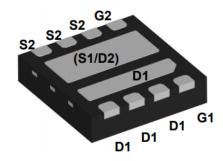
- > Applications
- Power Management in notebook computer
- Portable Equipment
- Battery Powered Systems

> Ordering Information

Device	Package	Shipping	
SSC8338GQ4	DFN3X3	5000/Reel	

> Pin configuration





Bottom View



Marking



Symbol	Parameter	Ratings	Unit	
V _{DSS}	Drain-to-Source Vo	30	V	
Vgss	Gate-to-Source Vo	±20	V	
		TC=25C°	16	А
D	Continuous Drain Current	TC=100C°	12	А
Ідм	Pulsed Drain Cur	65	А	
	Continuous Drain Current	TA=25 C°	14	А
ldsm	а	TA=70 C°	9	А
PD		TC=25C°	25	W
	Power Dissipation ^c	TC=100C°	10	W
_		TA=25 C°	2.5	W
Pdsm	Power Dissipation ^a	TA=70 C°	0.9	W
las	Avalanche Curr	Avalanche Current		
Eas	Avalanche Energy, L=	16	mJ	
TJ	Operation junction ten	-55 to 150	°C	
Tstg	Storage temperature	-55 to 150	°C	

➤ Absolute Maximum Ratings(T_A=25°C unless otherwise noted)

➤ Thermal Resistance Ratings(T_A=25[°]C unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
$R_{ extsf{ heta}JA}$	Junction-to-Ambient Thermal Resistance ^a		55	°C/W
$R_{ extsf{ heta}JC}$	R _{0JC} Junction-to-Case Thermal Resistance		6	C/ VV

Note:

- a. The value of RθJA is measured with the device mounted on 1 in² FR-4 board with 2oz.copper,in a still air environment with TA=25°C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation PD is based on TJ(MAX)=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.

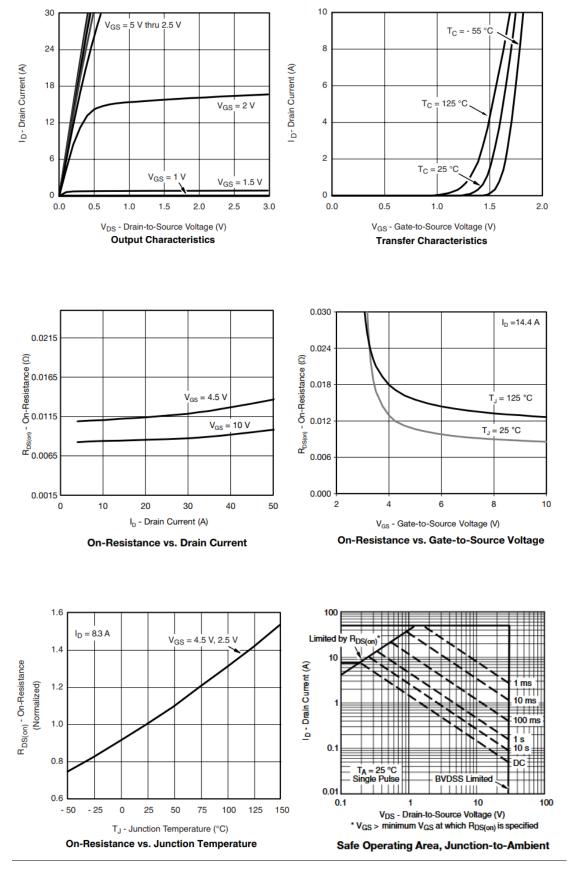


Electronics Characteristics(T_A=25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур.	Мах	Unit
V _{(BR)DSS}	Drain-Source Breakdown Voltage	VGS=0V,ID=250uA	30			V
$V_{GS \ (th)}$	Gate Threshold Voltage	VDS=VGS,ID=250uA	1.3	1.7	2.1	V
5	Drain-Source On-	VGS=10V,ID=20A		9.5	12	mR
R _{DS(on)}	Resistance	VGS=4.5V,ID=10A		12	15	
I _{DSS}	Zero Gate Voltage Drain Current	VDS=30V,VGS=0V			1	uA
I _{GSS}	Gate-Source leak	VGS=±20V,VDS=0V			±100	nA
V _{SD}	Forward Voltage	VGS=0V,IS=0.5A		0.8	1.3	V
G _{FS}	Transconductance	VDS=15V,ID=10A		55		S
Ciss	Input Capacitance			650		
Coss	Output Capacitance	VDS=15V, VGS=0V, f=1MHz		220		pF
Crss	Reverse Transfer Capacitance			105		
T _{D(ON)}	Turn-on delay time			12		
Tr	Rise time	VGS=10V,		6		
T _{D(OFF)}	Turn-off delay time	VDS=15V, RG=3R,RL=2.3R		22		ns
Tf	Fall time			9		
Qg	Total Gate charge			18		
Qgs	Gate to Source charge	VGS=10V, VDS=15V, ID=12A		2.3		nC
Qgd	Gate to Drain charge			3.2		

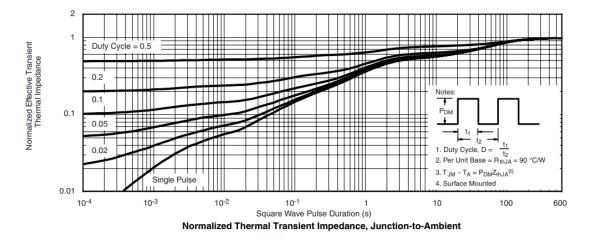


> Typical Characteristics (TA=25 $^{\circ}$ C unless otherwise noted)



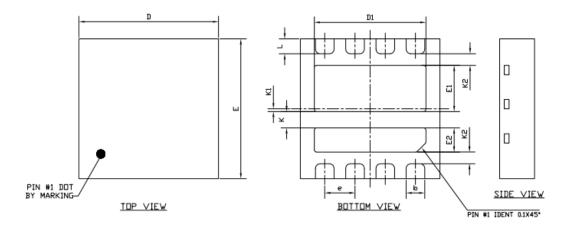


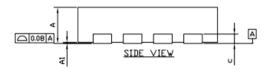
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> Package Information





SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES			
STRUCS	MIN	NDM	MAX	MIN	NDM	MAX	
A	0.70	0.75	0.80	0.028	0.030	0.032	
A1	0.00		0.05	0.000		0.002	
с	0.203 REF.				0.008 REF		
ю	0.35	0.40	0.45	0.014	0.016	0.018	
D	2.90	3.00	3.10	0.114	0.118	0.122	
D1	2.30	2.40	2.50	0.090	0.094	0.098	
E	2.90	3.00	3.10	0.114	0.118	0.122	
E1	0.89	0.99	1.09	0.035	0.039	0.043	
E2	0.42	0.52	0.62	0.016	0.020	0.024	
e	0.65 BSC				0.026 BSC		
L	0.27	0.32	0.37	0.011	0.013	0.015	
к	0.35 REF.			0.014 REF.			
К1	0.06 REF.				0.002 REF		
к2	0.25 REF.				0.010 REF		



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